COMPLIANT

HALOGEN

FREE



Vishay General Semiconductor

Avalanche Surface Mount Rectifiers



DO-214AA (SMB)

PRIMARY CHARACTERISTICS					
I _{F(AV)}	3.0 A				
V_{RRM}	600 V				
I _{FSM}	90 A				
t _{rr}	140 ns				
E _{AS}	20 mJ				
V_F at $I_F = 3.0$ A ($T_A = 125$ °C)	0.86 V				
T _J max.	175 °C				
Package	TO-277A (SMB)				
Diode variation	Single die				

TYPICAL APPLICATIONS

For use in general purpose rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, automotive, and telecommunication.

FEATURES

- Low profile package
- Ideal for automated placement
- · Glass passivated chip junction
- · Controlled avalanche characteristics
- Low leakage current
- · High forward surge capability
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

MECHANICAL DATA

Case: DO-214AA (SMB)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant and AEC-Q101 gualified

Base P/NHM3_X - halogen-free, RoHS-compliant and AEC-Q101 qualified

("_X" denotes revision code e.g. A, B,....)

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)						
PARAMETER		SYMBOL	AS3BD	AS3BG	AS3BJ	UNIT
Device marking code			A3D	A3G	A3J	
Maximum repetitive peak reverse voltage		V_{RRM}	200	400	600	V
Maximum DC forward current (fig. 1)		I _F ⁽¹⁾	3.0			А
		I _F (2)	2.0			
Peak forward surge current 10 ms single half sine-wave, non-repetitive, cool junction		I _{FSM}	90			Α
Non-repetitive avalanche energy at T _J = 25 °C	$I_{AS} = 2.0 A \text{ max}.$	_	E _{AS} 20 30		- mJ	
	$I_{AS} = 1.0 A \text{ typ.}$	∟AS				
Operating junction and storage temperature range		T _J , T _{STG}	-55 to +175			°C

Notes

- (1) Mounted on 14 mm x 14 mm x 2 areas, 1 oz. FR4 PCB
- (2) Free air, mounted on recommended 1.52 mm x 2.18 mm x 2 pad areas



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage	I _F = 1.5 A	T _A = 25 °C	V _F ⁽¹⁾	0.90	-	V	
	$I_F = 3.0 \text{ A}$			0.98	1.05		
	I _F = 1.5 A	T _A = 125 °C		0.78	-		
	$I_F = 3.0 \text{ A}$			0.86	0.95		
Reverse current	$V_R = 600 \text{ V}$ $T_A = 25 ^{\circ}\text{C}$ $T_A = 125 ^{\circ}$	T _A = 25 °C	I _R ⁽²⁾	A = 25 °C	0.5	20	
Reverse current		T _A = 125 °C		40	150	μΑ	
Typical reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A},$ $I_{rr} = 0.25 \text{ A}$		t _{rr}	1.5	-	μs	
Typical junction capacitance per diode	Rated V _R = 4.0) V, 1 MHz	СЈ	40	ı	pF	

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width \leq 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	AS3BJ	UNIT		
Tunical thermal registance	R _{θJA} ⁽¹⁾	100	°C/W		
Typical thermal resistance	R _{0JM} (2)	14			

Notes

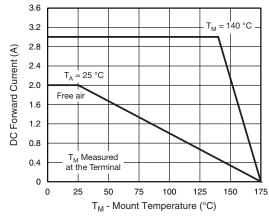
⁽¹⁾ Free air, mounted on recommended PCB 1 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient ⁽²⁾ Units mounted on PCB with 14 mm x 14 mm x 2 areas, 1 oz. copper pad areas; $R_{\theta JM}$ - junction to mount

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
AS3BJ-M3/52T	0.096	52T	750	7" diameter plastic tape and reel		
AS3BJ-M3/5BT	0.096	5BT	3200	13" diameter plastic tape and reel		
AS3BJHM3/52T (1)	0.096	52T	750	7" diameter plastic tape and reel		
AS3BJHM3/5BT (1)	0.096	5BT	3200	13" diameter plastic tape and reel		
AS3BJHM3_A/H (1)	0.096	Н	750	7" diameter plastic tape and reel		
AS3BJHM3_A/I (1)	0.096	I	3200	13" diameter plastic tape and reel		

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)





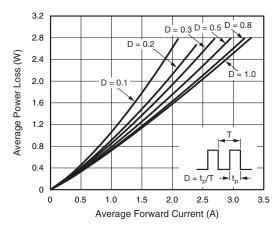


Fig. 2 - Forward Power Loss Characteristics



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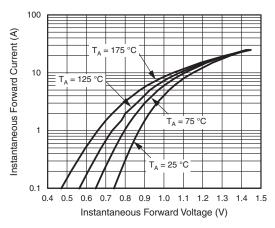


Fig. 3 - Typical Instantaneous Forward Characteristics

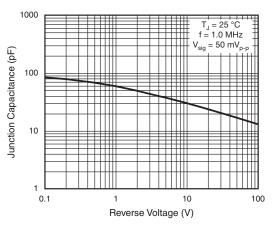


Fig. 5 - Typical Junction Capacitance

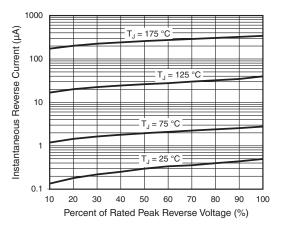


Fig. 4 - Typical Reverse Characteristics

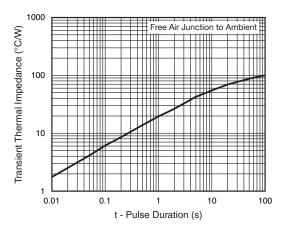
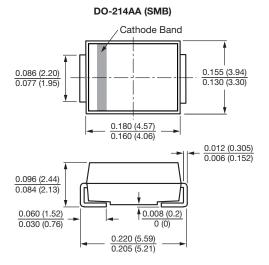
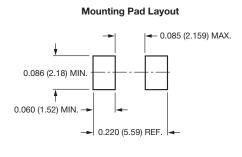


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)







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